

German Electronic Components High density board/unit assemble ODM maker; AEMtec GmbH Japan office opened

AEMtec GmbH

AEMtec GmbH, one of the leading high density board/unit assemble ODM maker in Germany, has established a Japan office (TEL. 81 3 6697 0156, in Fenetre Partners office, INAC building 4F, 5-18-23, Roppongi, Minato-ku, Tokyo, Japan). AEMtec began sales for Japanese companies.

AEMtec was established in 2000 spin-out from German semiconductor manufacturer Infineon, AEMtec has excellent technology for high precision semiconductors, sensor and device parts assembly. AEMtec is providing world top level high density assembly product that realizes customer requested specification. AEMtec owns facilities for processing semiconductor wafers back end service (forming bumps, solder balls, copper pillars on the electrodes of each chip, and dicing wafer to chips) and has advanced assemble technology such as chip on board, various flip chips and silicon via for mounting the semiconductor element directly on the board.

In Europe, AEMtec is receiving various sensor module orders from sensor makers and also receiving high density medical examination and treatment equipment modules orders from medical equipment manufacturers. (As an example, photodiode chip and ASIC chip are overlapped and connected through silicon via processing and it is assembled on flexible PCB board, this very small silicon via module is provided as ultralight weight medical scanner module.) In Japan, AEMtec is expecting customized demand for high density and high precision boards and modules assembly that is similar to, or higher than that of home Germany, from medical industry, optical electronics, industrial sensors, automotive modules, communication equipment etc. AEMtec will participate exhibitions such as Inter Opto 2018 (Oct. 17-19 @ Makuhari Messe), SEMICON JAPAN 2018 (Dec. 12-18 @ Tokyo Big Sight) and Nepcon Japan 2019 (Jan. 16-18 @ Tokyo Big Sight). AEMtec plans to have face-to-face communication with Japanese customers.

AEMtec GmbH

German Manufacturer of microelectronics and optoelectronics related modules having headquarters and manufacturing facilities in the Adlershof district, Berlin. Approximately 175 employees, Private Company

AEMtec Japan Office (this inquiry)

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